

股票代號 **7769**

2025Q4 法人說明會簡報

(2026/03)



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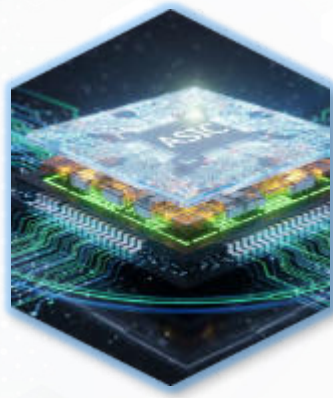


AGENDA



01

營運概況
Operation Update



02

成長動能
Growth Drivers



03

財務表現
Profitability



04

永續發展
ESG



營運概況

Operation Update

- 2026產能更新
- 訂單應用別分布
- 客戶地區分布



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2026產能更新



總人力規模

2026年+50%



可使用廠房面積

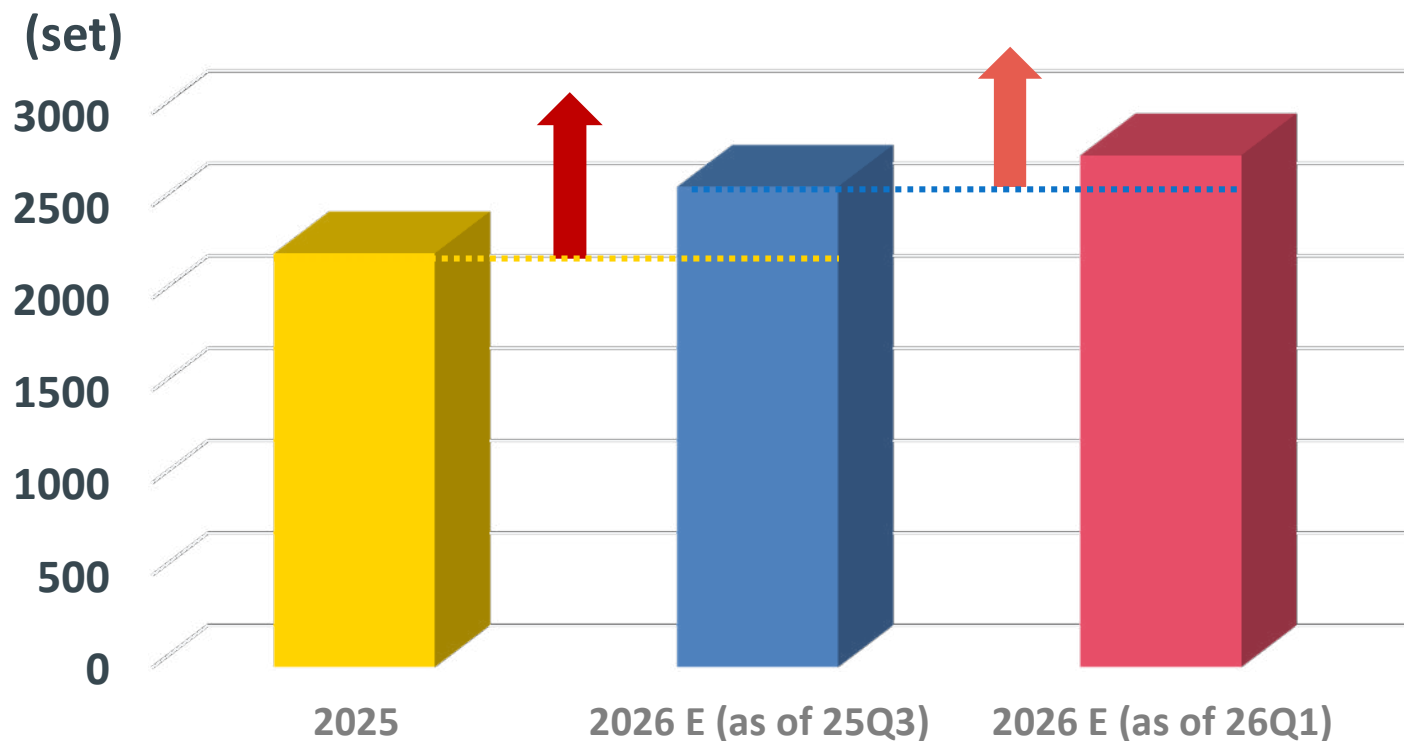
2026年+25%



採購額-加工件

2026年+40%

2026 ANNUAL CAPACITY FORECAST



訂單應用別分布

AI HPC ASIC



2025 2026/02
72% ▶ 79%

- ▶ AI Computing
- ▶ Server
- ▶ Networking
- ▶ APU/GPU/CPU/FPGA

Automotive



2025 2026/02
11% ▶ 9%

- ▶ Sensor
- ▶ MCU
- ▶ LiDAR

Mobile AP Communication



2025 2026/02
10% ▶ 10%

- ▶ SiP
- ▶ 5G OTA
- ▶ Power, PMIC
- ▶ Mobile Phone/AP
- ▶ RF Related Devices

3C Consumer



2025 2026/02
5% ▶ 1%

- ▶ AR glasses
- ▶ LCD driver
- ▶ CIS

Memory MEMS

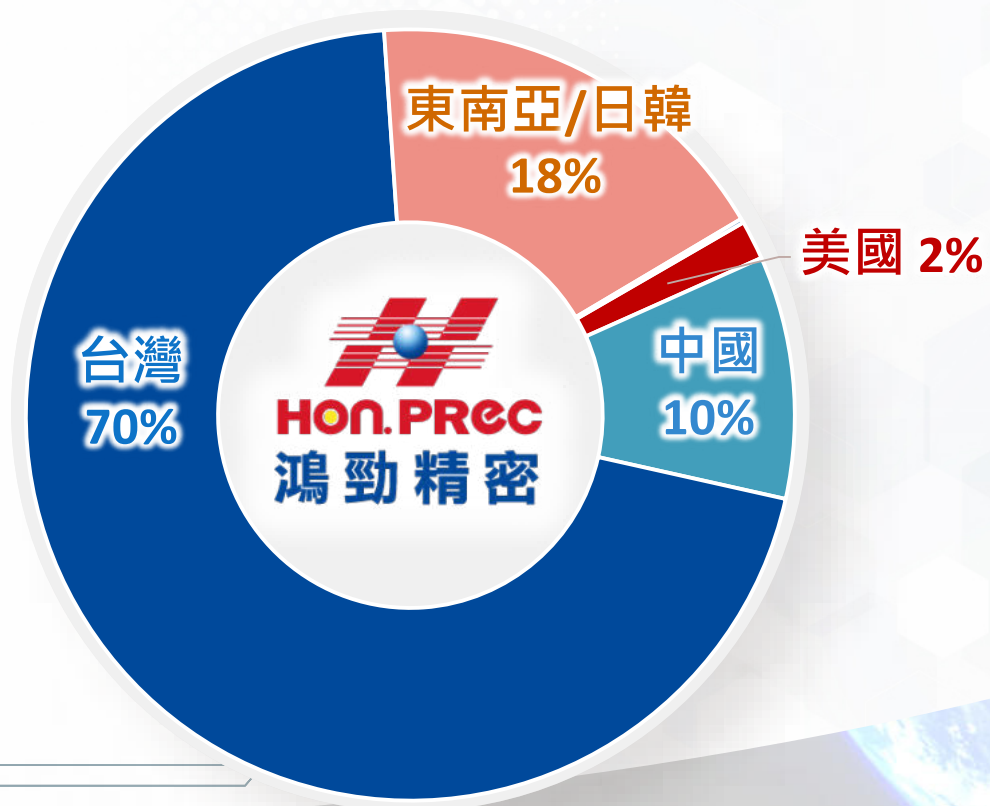


2025 2026/02
2% ▶ 1%

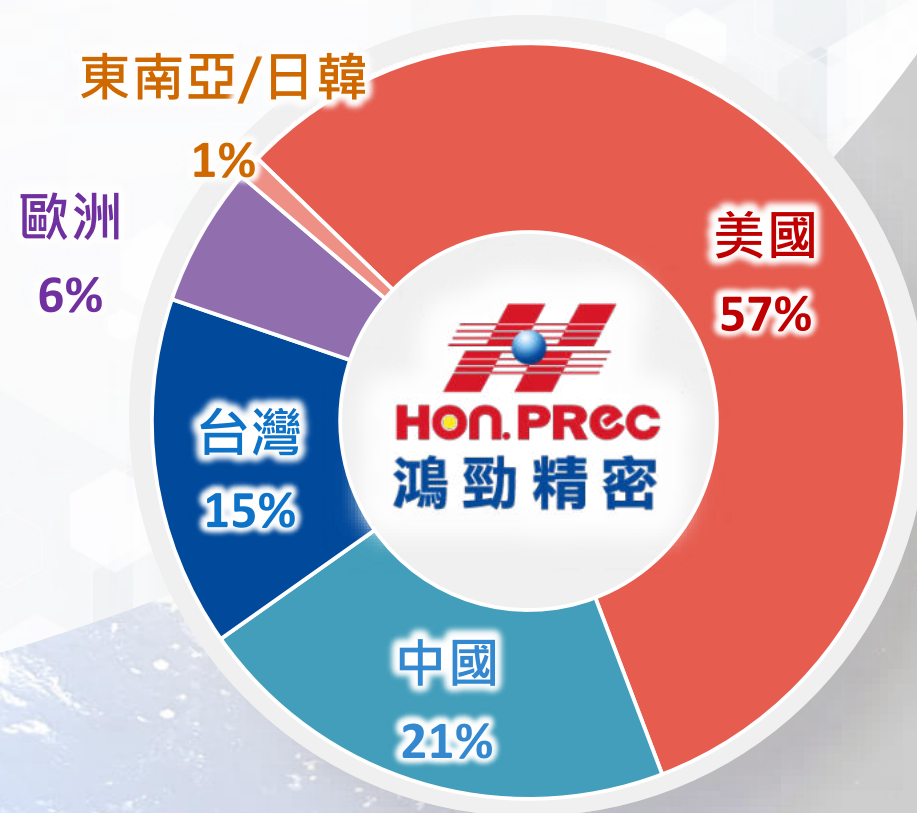
- ▶ Flash/DRAM Memory
- ▶ Accelerometer
- ▶ Gyroscope
- ▶ Barometer
- ▶ Light Sensor
- ▶ Pressure Sensor

客戶地區分布

出貨地區分布



終端客戶地區分布



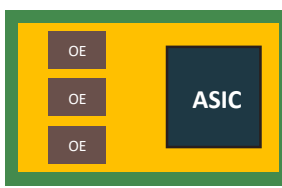
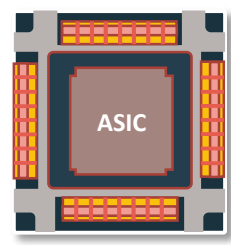
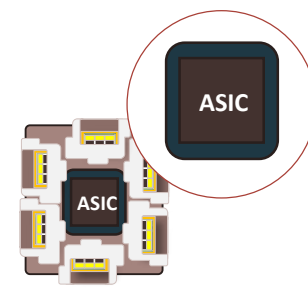
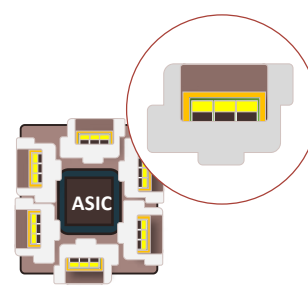
成長動能

Growth Drivers

- CPO
- 高階 FT ATC Handler 成長動能
- New Release For Final Test (FT)
- 高階 SLT ATC Handler 成長動能
- New Release For System Level IC Test (SLT)
- Active Thermal Control (ATC) Roadmap
- Cold Plate

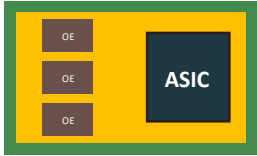
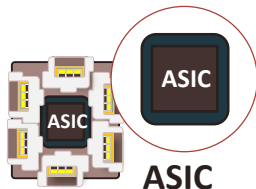
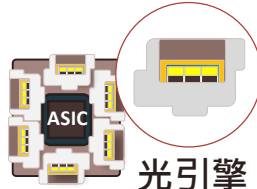
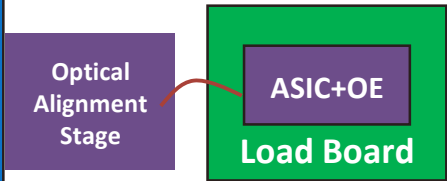
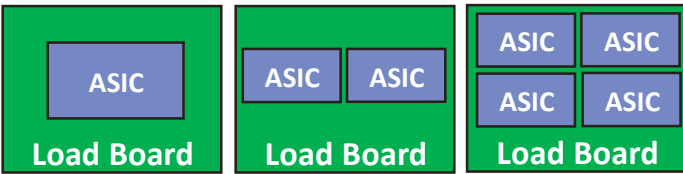
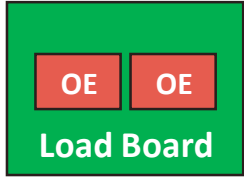


CPO Test Insertions

Test Insertion	Insertion 1	Insertion 2	Insertion 3	Insertion 4	CPO FT		
				共同開發中	量產中		
Test Content							
	PIC	EIC-PIC	光引擎	ASIC + 光引擎	ASIC + 光引擎	ASIC	光引擎
	Wafer Level (Foundry)	Wafer Level (Foundry)	DIE/Chip Level (OSAT)	Package-Level(OSAT)			
				光電同測	電性測試	電性測試	電性測試
HON.PREC Test Equipment	NA			ATE測試機+ATC (3KW) Handler	ATE測試機+ATC (2KW) Handler	ATE測試機+ATC (1KW) Handler	ATE測試機+ATC (1KW) Handler



CPO Insertion 4 and FT

Test Insertion	Insertion 4	CPO FT		
	共同開發中	量產中		
Test Content	 ASIC + 光引擎	 ASIC + 光引擎	 ASIC	 光引擎
	光電同測	電性測試	電性測試	電性測試
HON.PREC Test Equipment	ATE測試機+ATC Handler			
	3000W	2000W	1000W	1000W
	Single Site	Single Site	Single/Dual/Quad Site	Dual Site
				

高階 FT ATC Handler 成長動能



New Release For Final Test (FT)

CPO FT



- 光電同測 by ATE Tester
- Insertion 4
- Optical Engine & ASIC

Large Package



- 380X380 mm (Tray spec)
- 2000 kg contact force
- 支援 ATC 系統
- 支援 Full automation

MC Lid Handler



- 與合作夥伴同開發
- 自主研發機台機構及ATC 系統

WMCM Package



- 支援ATC 系統 (3000W)
- 8 / 16 sites

Top/Bottom AOI



- Top/Bottom AOI
- Current: 2D / Next: 3D

Hybrid Cooling Handler



- 支援切換氣冷/水冷/冷媒ATC
- 氣冷(16 sites)
- 水冷 (High power)

高階 SLT ATC Handler 成長動能



New Release For System Level IC Test (SLT)

Tri-Temp SLT



- -70°C~175°C (3000W)
- Support 6/8/12/20 sites

MSLT



- Full Automation
- 36~192 sites

ASIC SLT



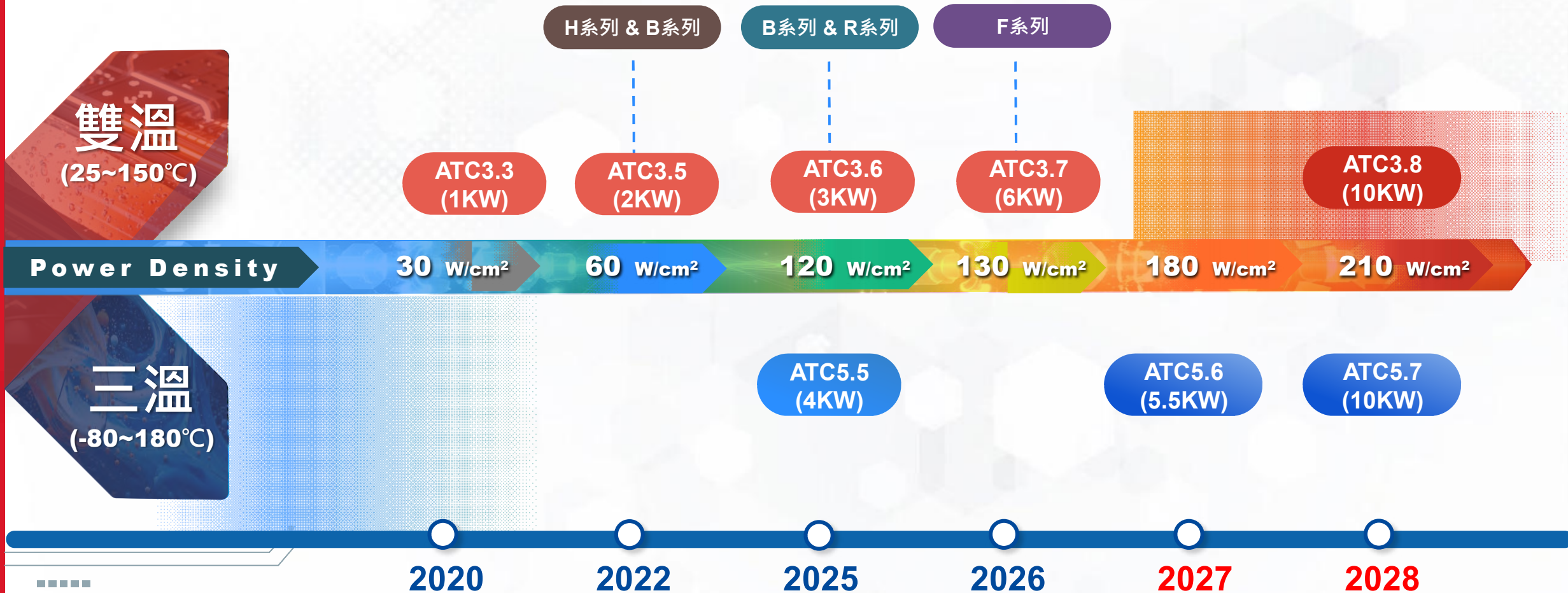
- 25°C~150°C (3000W)
- Support 6/12/24/36 sites

CPO 光引擎 SLT



- O/O Test

Active Thermal Control (ATC) Roadmap



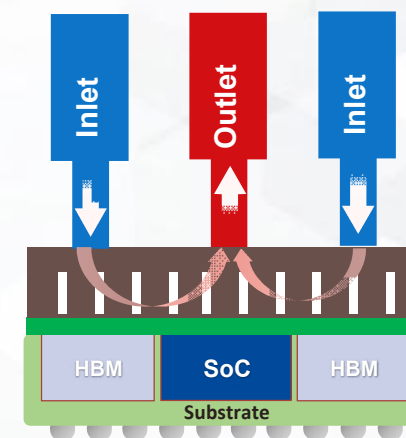
Cold Plate

Micro Channel Cold

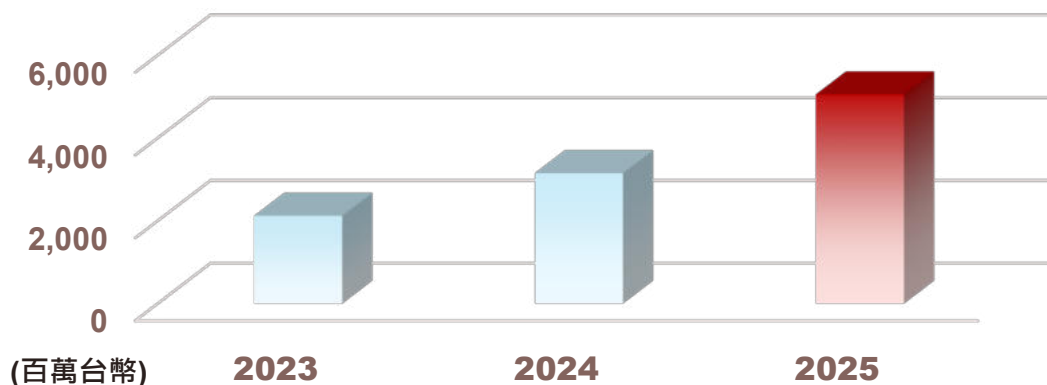
	Fin Cold Plate	MCCP
通道寬度	500um	150~200um
解熱密度	55W/cm2	120W/cm2
溫度轉換反應時間	7s	3s

Power Density
2倍
Increase

Micro Channel Lid



銷售金額



機台能力

品質檢測

微粒控制

溫度控制

平整度控制

財務表現

Profitability

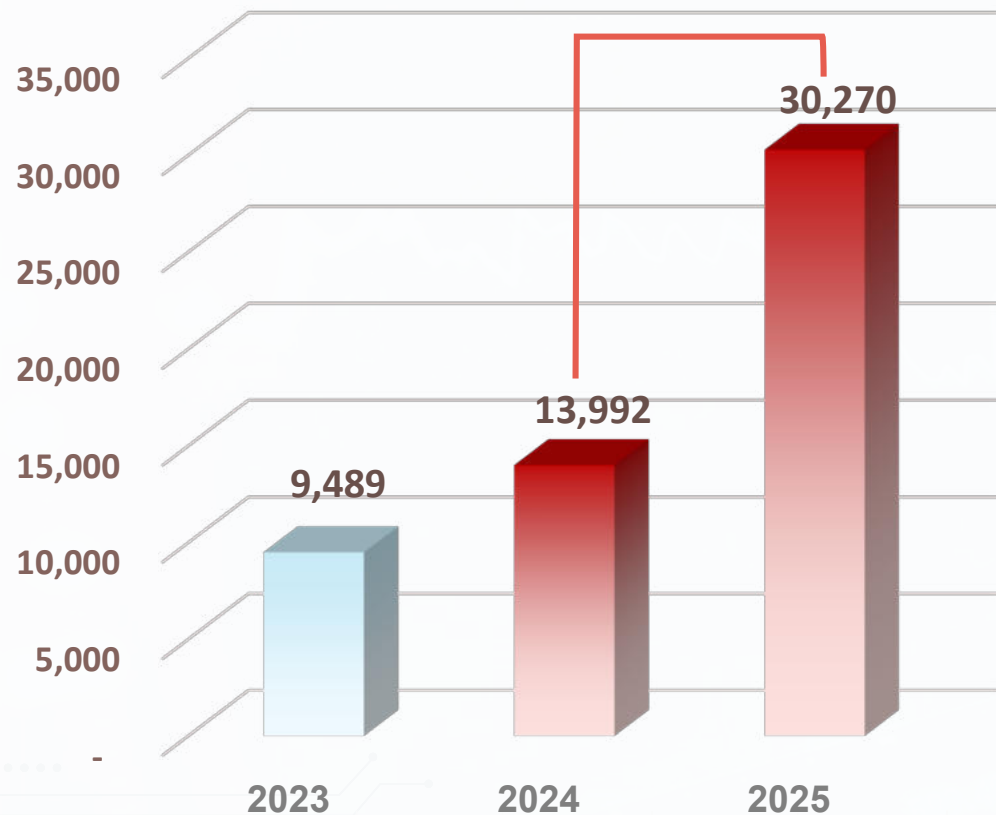
- 營收趨勢
- 毛利趨勢
- 淨利 & EPS
- 研發費用投入



營收趨勢

(百萬元台幣)

YoY **166.34%**



(百萬元台幣)

4,000

3,500

3,000

2,500

2,000

1,500

1,000

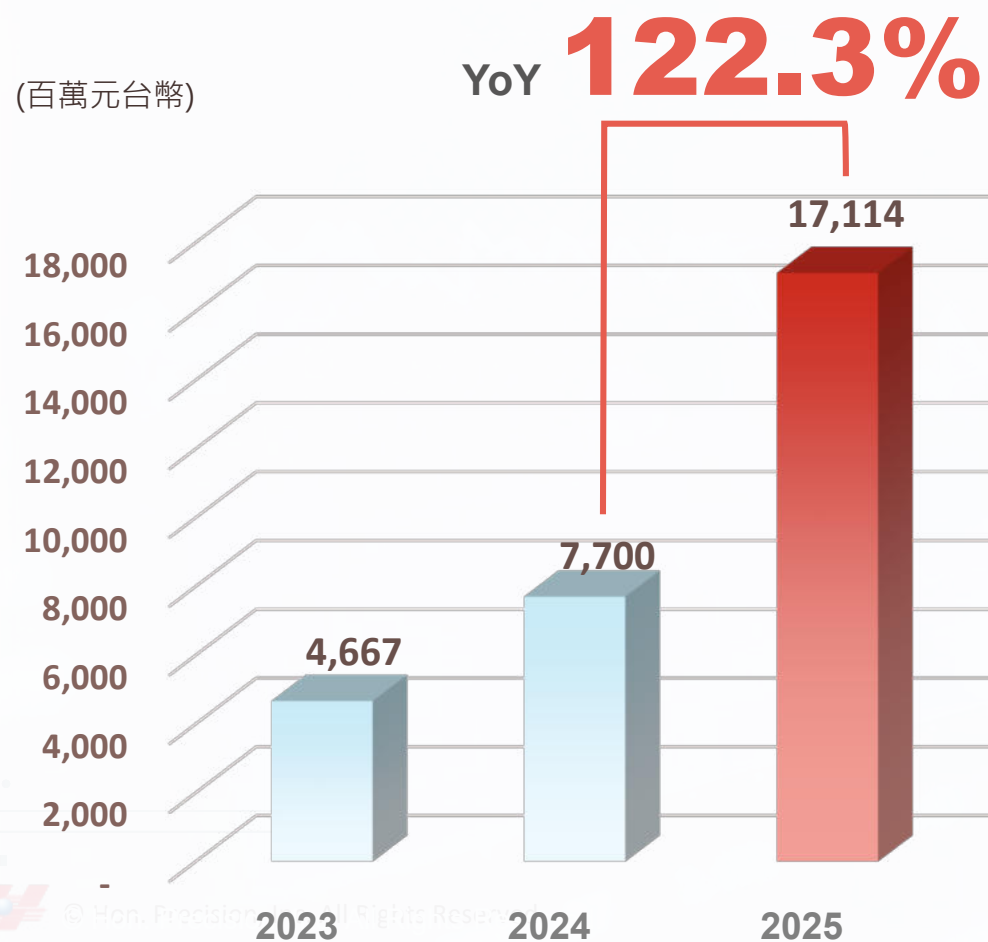
500

25/01 25/02 25/03 25/04 25/05 25/06 25/07 25/08 25/09 25/10 25/11 25/12 26/01 26/02

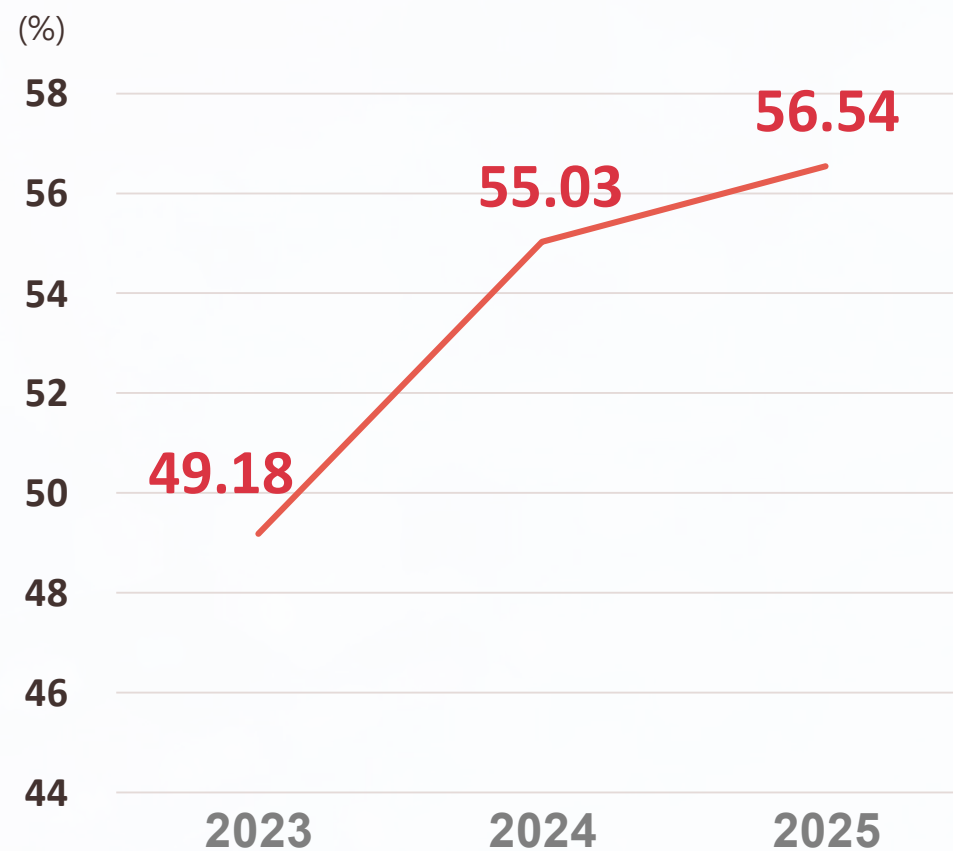


毛利趨勢

營業毛利



毛利率

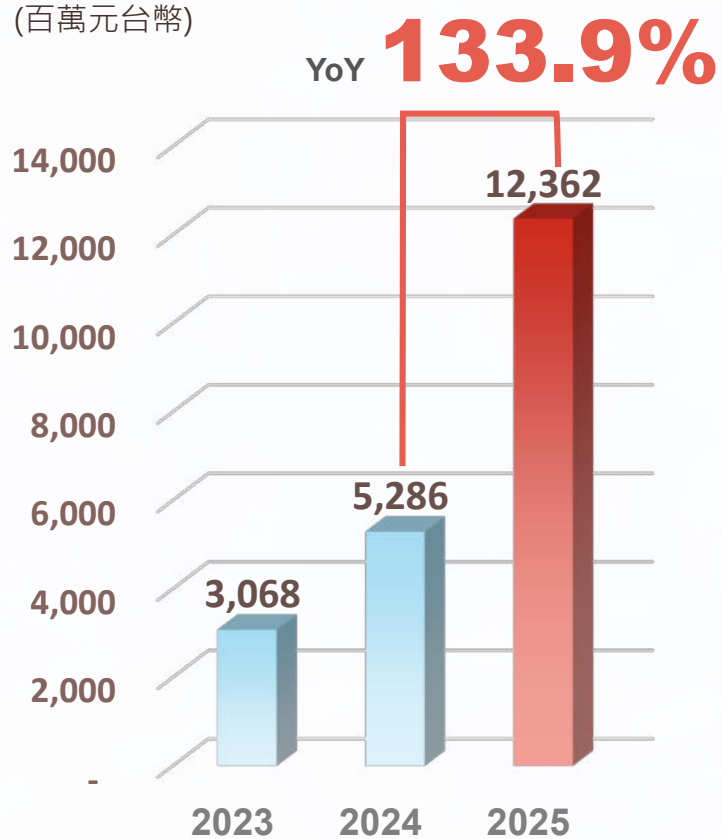


淨利 & EPS

	EPS (元)	加權平均股數(仟股)
2025	75.71	163,289
2024	32.95	160,446
2023	19.17	160,000

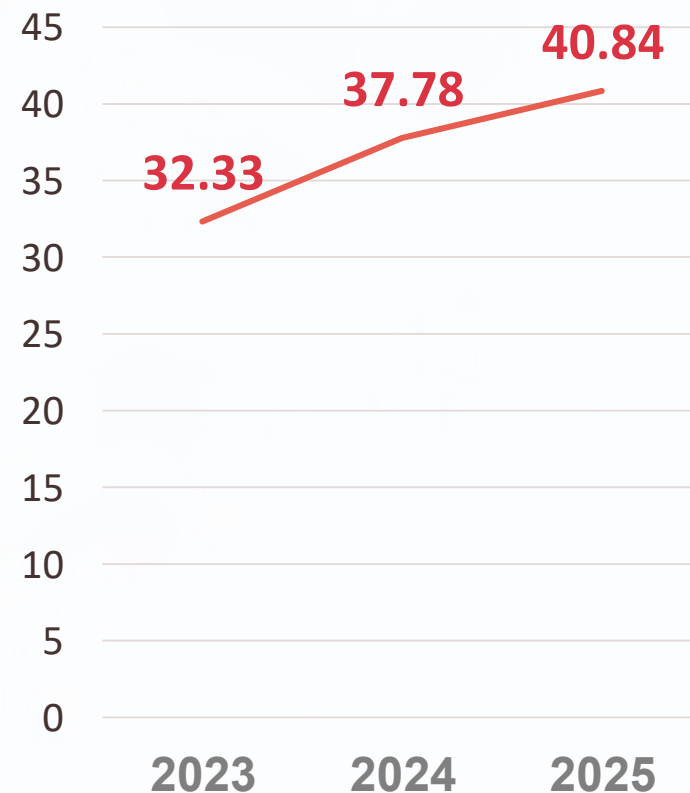
稅後淨利

(百萬元台幣)

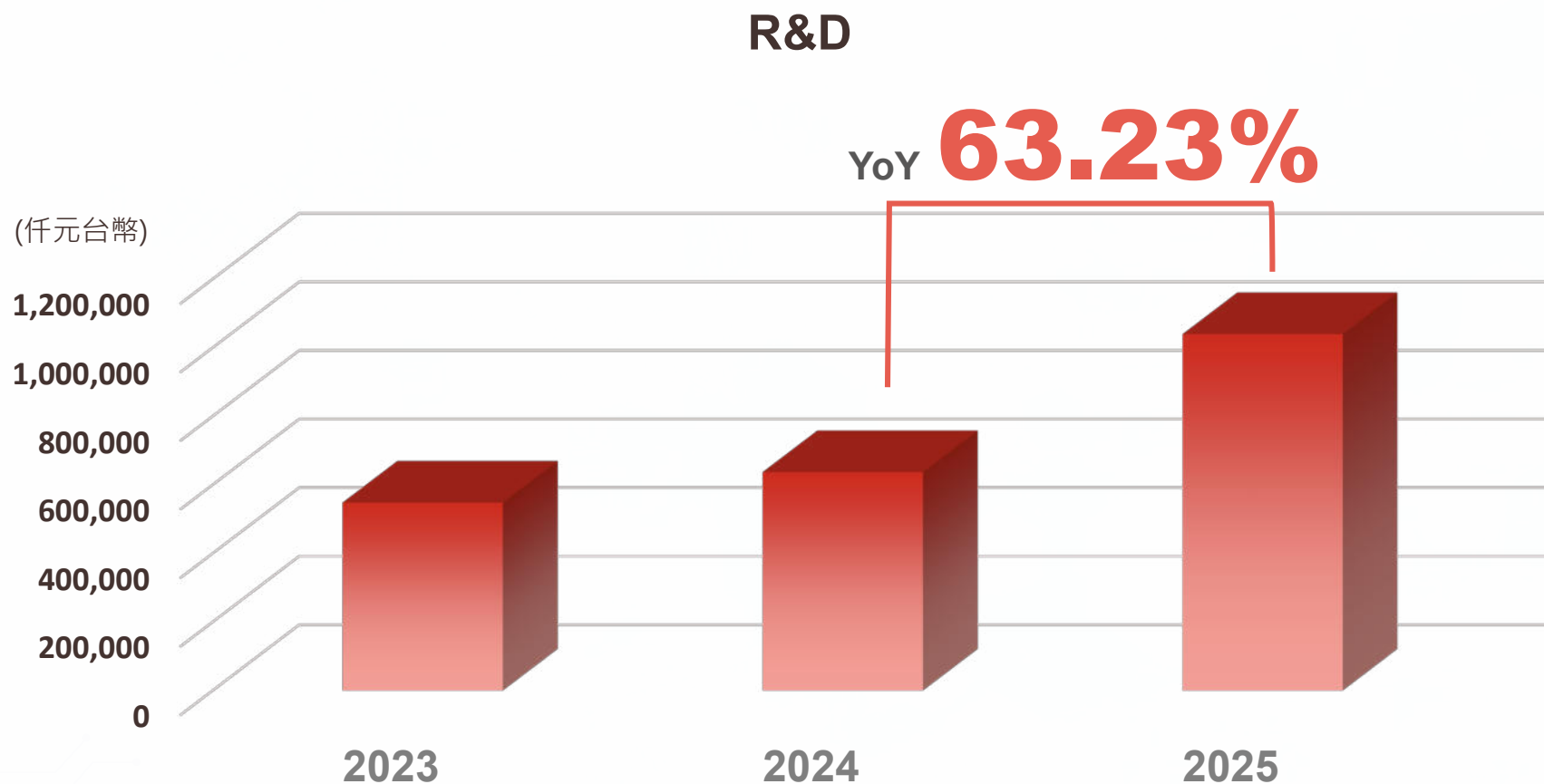


淨利率

(%)



研發費用投入



永續發展

ESG

- ESG未來發展策略
- ESG進度更新



ESG未來發展策略



環境保護 Environment

- 設置太陽能板，提升綠能使用比例
- 落實環安衛政策，確保環境安全
- 推動低碳供應鏈，減少碳足跡
- 通過 ISO 14064 溫室氣體盤查



公司治理 Governance

- 設置功能性委員會，提升治理效能
- 建立完善治理規章與制度



社會責任 Social

- 關懷弱勢，參與公益活動
- 推廣運動與健康生活
- 建立幸福職場文化
- 通過 ISO 45001 職安衛認證
- **成立鴻勁公益慈善基金會(26Q1)**



ESG進度更新

ESG Report TIMELINE



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資料收集之前置作業

- 收集永續議題收集及正負面衝擊
- 利害關係人鑑別
- 收集氣候相關財務揭露

重大議題確認

- 問卷發放與回收
- 矩陣與資料分析
- 議題決定

訪談及資料彙整

- 進行各單位訪談及收集量化資訊
- 彙整量化資訊
 - 風險管理政策
 - 溫室氣體及氣候排放
 - 能源/水資源及廢棄物管理
 - 人力資源
 - 供應鏈管理
 - 產品品質與安全
 - 資訊安全
 - 董事會及功能性委員會
 - 投資人溝通

報告撰寫及美編

- ESG 報告完成及上傳

DONE

3/9 ~ 4/15

4/16 ~ 5/15

5/16 ~ 6/30

Smarter Chips. Efficient Tomorrow.

Powered by Our Growth Drivers.

Questions & Answers

